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**UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: Bruno GHYSELEN et al.

Confirmation No.: 2668

Application No.: 10/726,039

Group Art Unit: 2818

Filing Date: December 1, 2003

Examiner: Dung Anh Le

For: RECYCLING OF A WAFER COMPRISING A  
BUFFER LAYER AFTER HAVING  
SEPARATED A THIN LAYER THEREFROM  
BY MECHANICAL MEANS

Attorney Docket No.: 4717-8600

**AMENDMENT AFTER ALLOWANCE**

Mail Stop Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

*Please, enter  
this paper.  
DL 3/20/06*

Sir:

Pursuant to 37 C.F.R. § 1.312 and MPEP 714.16, applicants submit the following amendments and remarks for entry into the record of this application.

**AMENDMENT TO THE SPECIFICATION** appears on page 2 of this paper.

**REMARKS** begin on page 3 of this paper.

No fee is believed to be due for this response. Should any fees be required, however, please charge such fees to Winston & Strawn LLP Deposit Account No. 50-1814.